

# PESD1LVDS

# ESD protection for in-vehicle ultra high-speed interfaces Rev. 2 — 23 January 2013 Product data

Product data sheet

### 1. **Product profile**

### 1.1 General description

The device is designed to protect in-vehicle ultra high-speed interfaces in automotive applications, such as Low-Voltage Differential Signaling (LVDS), High-Definition Multimedia Interface (HDMI) and DisplayPort interfaces against ElectroStatic Discharge (ESD).

The device is housed in an ultra small SOT1165-1 (XSON10) Surface-Mounted Design (SMD) plastic package.

# 1.2 Features and benefits

- System ESD protection for LVDS, HDMI and DisplayPort interfaces
- Line capacitance of only 0.6 pF with ≤ 0.05 pF matching capacitance between signal pairs
- Ultra small XSON10 package with design-friendly 'pass-thru' signal routing
- AEC-Q101 qualified

# 1.3 Applications

The devices are designed for high-speed receiver and transmitter port protection:

Automotive A/V monitors, displays and cameras

### 1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{RWM}$	reverse standoff voltage		-	-	5.5	V
$C_{ch}$	channel capacitance	f = 1 MHz; $V_{bias} = 2.5 V$	<u>[1]</u> -	0.6	-	pF

<sup>[1]</sup> This parameter is guaranteed by design.



# ESD protection for in-vehicle ultra high-speed interfaces

# 2. Pinning information

Table 2. Pinning

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	CH1-	negative channel 1 ESD protection	[10] [9] 8 [7] [6]	1 2 4 5
2	CH1+	positive channel 1 ESD protection	1 2 3 4 5	
3	GND	ground	Transparent top view	
4	CH2-	negative channel 2 ESD protection	XSON10	3.8
5	CH2+	positive channel 2 ESD protection		001aai619
6	n.c.	not connected		
7	n.c.	not connected		
8	GND	ground		
9	n.c.	not connected		
10	n.c.	not connected		

# 3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PESD1LVDS	XSON10	plastic extremely thin small outline package; no leads; 10 terminals; body 1 $\times$ 2.5 $\times$ 0.5 mm	SOT1165-1

# 4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$T_{stg}$	storage temperature		-55	+125	°C
T <sub>amb</sub>	ambient temperature		-40	+85	°C

### Table 5. ESD maximum ratings

 $T_{amb} = 25$  °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{ESD}$	electrostatic discharge voltage	IEC 61000-4-2 (contact discharge)	<u>[1][2]</u> -	±8	kV

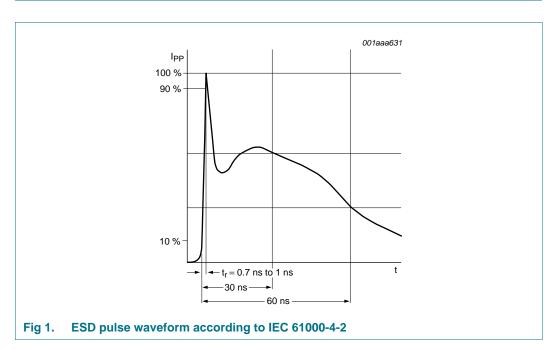
<sup>[1]</sup> Device stressed with ten non-repetitive ESD pulses.

[2] All pins to ground.

# ESD protection for in-vehicle ultra high-speed interfaces

Table 6. ESD standards compliance

Standard	Conditions
IEC 61000-4-2; level 4 (ESD)	> 8 kV (contact)
MIL-STD-883; class 3B (human body model)	> 8 kV



# 5. Characteristics

Table 7. Characteristics

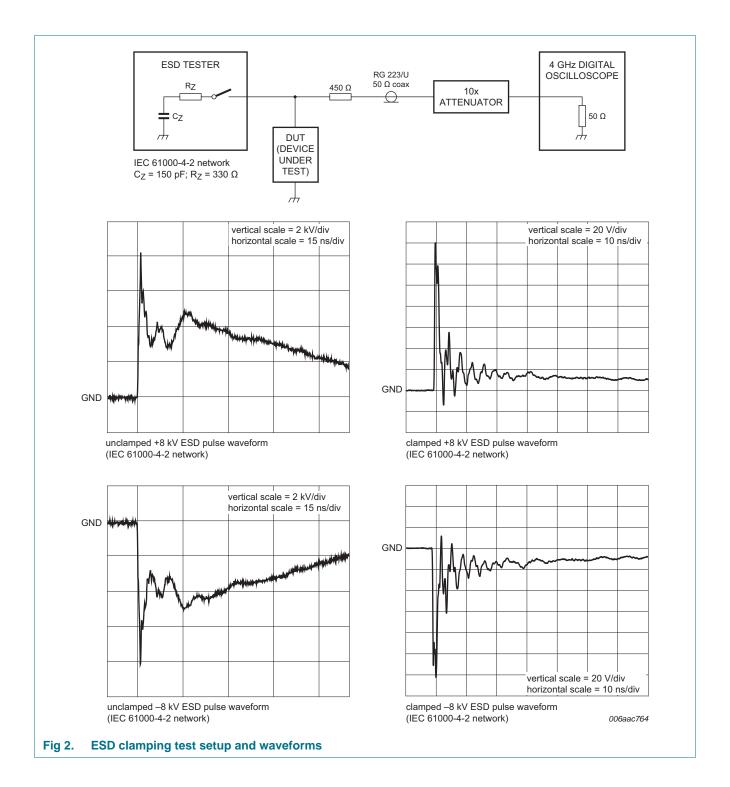
 $T_{amb} = 25$  °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{RWM}$	reverse standoff voltage			-	-	5.5	V
I <sub>RM</sub>	reverse leakage current	per channel; V = 3.0 V		-	-	1	μΑ
$V_{BR}$	breakdown voltage	I = 1 mA		6	-	9	V
V <sub>F</sub>	forward voltage			-	0.7	-	V
$C_{(I/O\text{-}GND)}$	input/output to ground capacitance	f = 1 MHz; $V_{bias} = 2.5 V$	<u>[1]</u>	-	0.6	-	pF
$\Delta C_{\text{(I/O-GND)}}$	input/output to ground capacitance variation	f = 1 MHz; $V_{bias} = 2.5 V$	[1]	-	0.05	-	pF
C <sub>ch(mutual)</sub>	mutual channel capacitance	f = 1 MHz; $V_{bias} = 2.5 V$	[1][2]	-	0.07	-	pF

<sup>[1]</sup> This parameter is guaranteed by design.

<sup>[2]</sup> Between signal pin and pin n.c.

# ESD protection for in-vehicle ultra high-speed interfaces



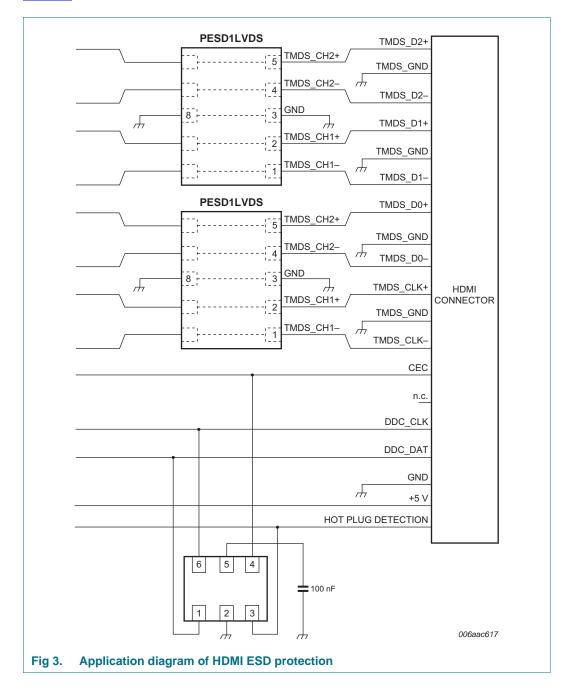
### ESD protection for in-vehicle ultra high-speed interfaces

# 6. Application information

The devices are designed to provide high-level ESD protection for high-speed serial data buses such as LVDS, HDMI and DisplayPort data lines.

When designing the Printed-Circuit Board (PCB), careful consideration should be given to impedance matching, and signal coupling.

Basic application diagrams for the ESD protection of an HDMI interface are shown in Figure 3.



# ESD protection for in-vehicle ultra high-speed interfaces

# 7. Test information

# 7.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

### ESD protection for in-vehicle ultra high-speed interfaces

# 8. Package outline

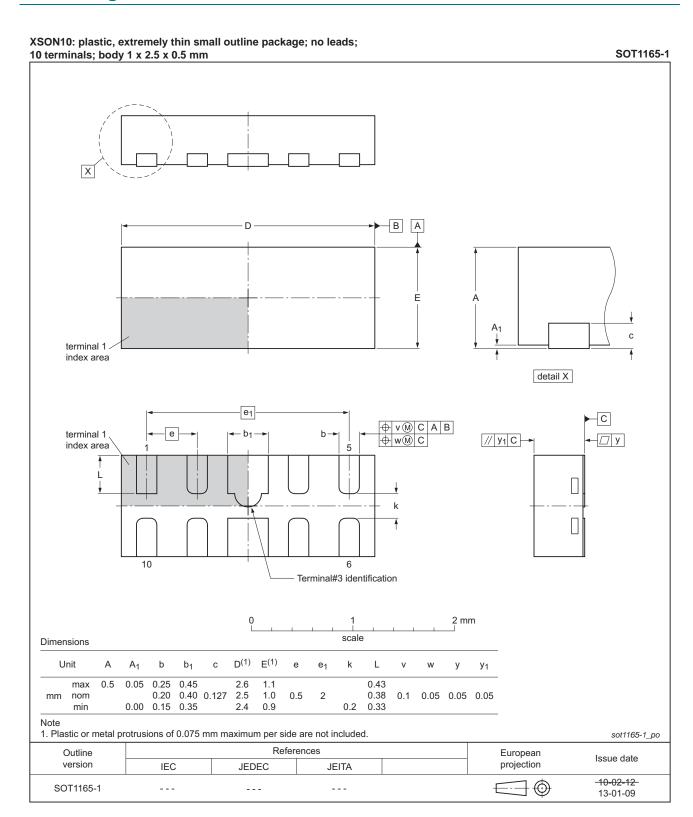
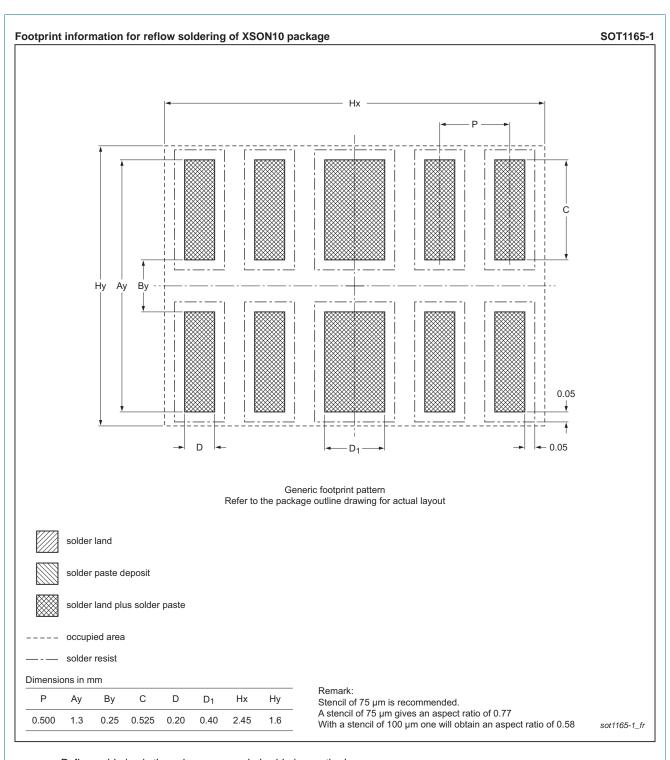


Fig 4. Package outline SOT1165-1 (XSON10)

# ESD protection for in-vehicle ultra high-speed interfaces

# 9. Soldering



Reflow soldering is the only recommended soldering method.

Fig 5. Reflow soldering footprint SOT1165-1 (XSON10)

# ESD protection for in-vehicle ultra high-speed interfaces

# 10. Revision history

# Table 8. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PESD1LVDS v.2	20130123	Product data sheet	-	PESD1LVDS v.1
Modifications:	• Figure 4 "Pa	nckage outline SOT1165-1 (XS	SON10)": updated	
PESD1LVDS v.1	20111010	Product data sheet	-	-

### ESD protection for in-vehicle ultra high-speed interfaces

# 11. Legal information

### 11.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
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